506060121 05/14/2020

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6106835

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date	
ERIC ZBINDEN	01/17/2018	
JIGNESH H. SHAH	01/19/2018	

RECEIVING PARTY DATA

Name:	SAMTEC, INC.
Street Address:	520 PARK EAST BOULEVARD
City:	NEW ALBANY
State/Country:	INDIANA
Postal Code:	47150

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16764142

CORRESPONDENCE DATA

Fax Number: (215)568-3439

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 215-568-3100

Email: assignments@woodcock.com

Correspondent Name: BAKERHOSTETLER / SAMTEC, INC.

Address Line 1: CIRA CENTRE 12TH FLOOR

Address Line 2: 2929 ARCH STREET

Address Line 4: PHILADELPHIA, PENNSYLVANIA 19104-2891

ATTORNEY DOCKET NUMBER:	107030.000257
NAME OF SUBMITTER:	VALERIE CHICCHI
SIGNATURE:	/Valerie Chicchi/
DATE SIGNED:	05/14/2020

Total Attachments: 4

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PATENT 506060121 REEL: 052663 FRAME: 0770

DOCKET NO.: 107030.000068 / S1041A

ASSIGNMENT

WHEREAS, I, Eric Zbinden, citizen of Switzerland, c/o 520 Park East Boulevard, New Albany, Indiana 47150, ASSIGNOR, am an inventor of one or more inventions disclosed, described and/or claimed in the application referred to as Application Number 62/614,626 filed January 8, 2018 ("the invention"), which is entitled CONNECTORS ("the subject application").

AND WHEREAS, **SAMTEC INC.**, ASSIGNEE, having a place of business at **520 Park East Boulevard**, **New Albany**, **Indiana 47150**, is desirous of obtaining my entire right, title, and interest in, to, and under the invention:

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I, the ASSIGNOR, hereby sell, assign, transfer, and set over, unto the ASSIGNEE, its successors, legal representatives, and assigns, my entire right, title, and interest in, to, and under the invention, and all applications for industrial property protection. including without limitation, all applications for patents, utility models, inventors' certificates, and designs that have been filed, and that may hereafter be filed, in any country, that disclose, describe, and/or claim the invention, including, without limitation, the subject application and the priority application, and all extensions, renewals, and reissues of such applications. including all divisions and continuations in whole or in part; all patents granted on such applications in any country, and all extensions, renewals, and reissues of such patents, including all divisions and continuations in whole or in part; the right to file such applications in any country; and the right to claim for such applications in any country the priority rights derived from the priority application and the subject application under the International Convention for the Protection of Industrial Property, the Patent Laws of the United States, any other international agreement or protection, or the domestic laws of any country in which any such application is filed, as may be applicable.

AND I HEREBY covenant and agree that I have full right to convey my entire interest herein assigned, and that I have not executed, and will not execute, any agreement in conflict herewith.

AND I HEREBY further covenant and agree that I will communicate to the ASSIGNEE, its successors, legal representatives, and assigns, any facts known to me respecting the invention, and testify in any legal proceeding, sign all lawful papers, execute all disclaimers and all divisional, continuing, reissue, and foreign applications, make all rightful oaths, deliver upon request all papers, documents, affidavits, or other instruments that may be necessary or helpful in the prosecution of any application for industrial property protection describing and/or claiming the invention, and generally do everything possible to aid the ASSIGNEE, its successors,

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legal representatives, and assigns, to obtain and enforce proper protection for the invention in all countries.

IN TESTIMO	NY WHEREOF, II	have signed my name	e below on the da	ate indicat	ed above my
signature.					
Executed this	/]day of	, January.,	ear of <u>2018</u>		
· · · · · · · · · · · · · · · · · · ·	<u> </u>	<u>.</u>			
Signature					
Eric Zbinden	* *				
********	*****	******	*****	*****	*****
STATEMENT OF W	YITNESS				
SIGNED at <u>San</u> j	k Clare	(B)			
(City)		(Country)			
This <u>/</u> day of	TANKARY	, 201 <u>§</u> .			
1, <u>Zzyano</u>	1 /ce-		whose full		
residence address	is <u>43662</u>	<u> Cabo A</u>	Frank	<u>Car</u>	245.59
		e Eric Zbinden execu			
	š	01 🤾 , and such as	signor is personi	ally knowi	i to me to be
the person describ	ped in such docum	nent			
Signature of Witn	25S				
Jugar Jan					

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ASSIGNMENT

WHEREAS, I, Jignesh H. Shah, citizen of the United States of America, c/o 2323 Owen Street, Suite 120, Santa Clara, California 95054, ASSIGNOR, am an inventor of one or more inventions disclosed, described and/or claimed in the application referred to as Application Number 62/614,626 filed January 8, 2018 ("the invention"), which is entitled CONNECTORS ("the subject application").

AND WHEREAS, **SAMTEC INC.**, ASSIGNEE, having a place of business at **520 Park East Boulevard**, **New Albany**, **Indiana 47150**, is desirous of obtaining my entire right, title, and interest in, to, and under the invention:

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I, the ASSIGNOR, hereby sell, assign, transfer, and set over, unto the ASSIGNEE, its successors, legal representatives, and assigns, my entire right, title, and interest in, to, and under the invention, and all applications for industrial property protection, including without limitation, all applications for patents, utility models, inventors' certificates, and designs that have been filed, and that may hereafter be filed, in any country, that disclose, describe, and/or claim the invention, including, without limitation, the subject application and the priority application, and all extensions, renewals, and reissues of such applications, including all divisions and continuations in whole or in part; all patents granted on such applications in any country, and all extensions, renewals, and reissues of such patents, including all divisions and continuations in whole or in part; the right to file such applications in any country; and the right to claim for such applications in any country the priority rights derived from the priority application and the subject application under the International Convention for the Protection of Industrial Property, the Patent Laws of the United States, any other international agreement or protection, or the domestic laws of any country in which any such application is filed, as may be applicable.

AND I HEREBY covenant and agree that I have full right to convey my entire interest herein assigned, and that I have not executed, and will not execute, any agreement in conflict herewith.

AND I HEREBY further covenant and agree that I will communicate to the ASSIGNEE, its successors, legal representatives, and assigns, any facts known to me respecting the invention, and testify in any legal proceeding, sign all lawful papers, execute all disclaimers and all divisional, continuing, reissue, and foreign applications, make all rightful oaths, deliver upon request all papers, documents, affidavits, or other instruments that may be necessary or helpful in the prosecution of any application for industrial property protection describing and/or claiming the invention, and generally do everything possible to aid the ASSIGNEE, its successors,

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legal representatives, and assigns, to obtain and enforce proper protection for the invention in all countries.

IN TESTIMONY WHEREOF, I have signed my name below on the date indicated above my
signature.
Executed this 19 day of January, year of 2018.
Jiguesh H. Sheh
lignesh H. Shah

STATEMENT OF WITNESS
SIGNED at Santa Clara USA
(City) (Country)
This 19 day of January, 2018. , JAMES GRAYSON whose full
, JAMES GRAYSON whose full
residence address is 76 MURLAGAN AVE #2
MOUNTAIN VIEW, CA 94043
was personally present and did see Jignesh H. Shah execute the above assignment on the 19 ¹⁴ day of <u>January</u> , 201 <u>S</u> , and such assignor is personally known to me to be the person described in such document.
Signature of Witness $^{ u}$

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RECORDED: 05/14/2020